BUK109-50DL

DESCRIPTION

Monolithic temperature and overload protected logic level power MOSFET in a 3 pin plastic surface mount envelope, intended as a general purpose switch for automotive systems and other applications.

APPLICATIONS

General controller for driving

- lamps
- motors
- solenoids
- heaters

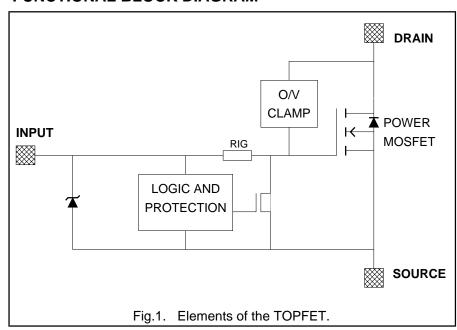
FEATURES

- Vertical power DMOS output stage
- Low on-state resistance
- Overload protection against over temperature Overload protection against
- short circuit load
- Latched overload protection reset by input
- 5 V logic compatible input level
- Control of power MOSFET and supply of overload protection circuits derived from input
- Lower operating input current permits direct drive by micro-controller
- ESD protection on input pin
- Overvoltage clamping for turn off of inductive loads

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{DS} I _D P _D T _j R _{DS(ON)}	Continuous drain source voltage Continuous drain current Total power dissipation Continuous junction temperature Drain-source on-state resistance	50 26 75 150 60	V A W °C mΩ
I _{ISL}	Input supply current $V_{IS} = 5 \text{ V}$	650	μА

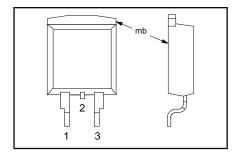
FUNCTIONAL BLOCK DIAGRAM



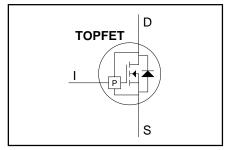
PINNING - SOT404

PIN	DESCRIPTION
1	input
2	drain
3	source
mb	drain

PIN CONFIGURATION



SYMBOL



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LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{DS}	Continuous drain source voltage ¹	-	-	50	V
V _{IS}	Continuous input voltage	-	0	6	V
I _D	Continuous drain current	$T_{mb} \le 25 \text{ °C}; V_{IS} = 5 \text{ V}$	-	26	Α
I _D	Continuous drain current	$T_{mb} \le 100 ^{\circ}C; V_{IS} = 5 V$	-	16	Α
I _{DRM}	Repetitive peak on-state drain current	$T_{mb} \le 25 ^{\circ}C; V_{IS} = 5 V$	-	100	Α
P _D	Total power dissipation	$T_{mb} \leq 25 ^{\circ}C$	-	75	W
T _{stg}	Storage temperature	-	-55	150	°C
T _j	Continuous junction temperature ²	normal operation	-	150	°C
T _{sold}	Lead temperature	during soldering	-	250	°C

OVERLOAD PROTECTION LIMITING VALUES

With the protection supply provided via the input pin, TOPFET can protect itself from two types of overload.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{ISP}	Protection supply voltage ³	for valid protection	4	-	V
	Over temperature protection				
$V_{DDP(T)}$	Protected drain source supply voltage	$V_{IS} = 5 V$	-	50	V
$V_{DDP(P)}$	Short circuit load protection ⁴ Protected drain source supply voltage ⁵	V _{IS} = 5 V	-	20	V
P _{DSM}	Instantaneous overload dissipation	$T_{mb} = 25 ^{\circ}C$	-	1.3	kW

OVERVOLTAGE CLAMPING LIMITING VALUES

At a drain source voltage above 50 V the power MOSFET is actively turned on to clamp overvoltage transients.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _{DROM} E _{DSM}	Repetitive peak clamping current Non-repetitive clamping energy	$V_{IS} = 0 V$ $T_{mb} \le 25 \text{ °C}; I_{DM} = 26 \text{ A};$	-	26 625	A mJ
E _{DRM}	Repetitive clamping energy	$V_{DD} \le 20 \text{ V; inductive load}$ $T_{mb} \le 95 \text{ °C; } I_{DM} = 8 \text{ A;}$ $V_{DD} \le 20 \text{ V; } f = 250 \text{ Hz}$	-	40	mJ

ESD LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _C	Electrostatic discharge capacitor voltage	Human body model; C = 250 pF; R = 1.5 kΩ	1	2	kV

¹ Prior to the onset of overvoltage clamping. For voltages above this value, safe operation is limited by the overvoltage clamping energy.

² A higher T_j is allowed as an overload condition but at the threshold $T_{j(TO)}$ the over temperature trip operates to protect the switch.

³ The input voltage for which the overload protection circuits are functional.

⁴ For further information, refer to OVERLOAD PROTECTION CHARACTERISTICS.

⁵ The short circuit load protection is able to save the device providing the instantaneous on-state dissipation is less than the limiting value for P_{DSM_7} which is always the case when V_{DS} is less than $V_{DDP(P)}$ maximum.

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Thermal resistance					
R _{th j-mb}	Junction to mounting base	-	-	1.3	1.67	K/W
R _{th j-a}	Junction to ambient	minimum footprint FR4 PCB (see fig. 23)	-	50	-	K/W

STATIC CHARACTERISTICS

 $T_{mb} = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(CL)DSS}$	Drain-source clamping voltage	$V_{IS} = 0 \text{ V}; I_D = 10 \text{ mA}$	50	-	-	V
$V_{(CL)DSS}$	Drain-source clamping voltage	$V_{IS} = 0 \text{ V}; I_{DM} = 2 \text{ A}; t_p \le 300 \mu\text{s}; \\ \delta \le 0.01$	-	-	70	V
I _{DSS}	Zero input voltage drain current	$V_{DS} = 12 \text{ V}; V_{IS} = 0 \text{ V}$	-	0.5	10	μΑ
I _{DSS}	Zero input voltage drain current		-	1	20	μΑ
I _{DSS}	Zero input voltage drain current	$V_{DS} = 40 \text{ V}; V_{IS} = 0 \text{ V}; T_{i} = 125 \text{ °C}$	-	10	100	μΑ
R _{DS(ON)}	Drain-source on-state	$V_{IS} = 5 \text{ V}; I_{DM} = 13 \text{ A}; t_p \le 300 \mu\text{s};$	-	45	60	mΩ
	resistance ¹	$\delta \leq 0.01$				

OVERLOAD PROTECTION CHARACTERISTICS

TOPFET switches off when one of the overload thresholds is reached. It remains latched off until reset by the input.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
E _{DS(TO)} t _{d sc} I _{D(SC)}	Short circuit load protection ² Overload threshold energy Response time Drain current ³	$\begin{split} T_{mb} &= 25 \text{ °C; L} \leq 10 \mu\text{H; R}_{L} = 10 m\Omega \\ V_{DD} &= 13 \text{ V; V}_{IS} = 5 \text{ V} \\ V_{DD} &= 13 \text{ V; V}_{IS} = 5 \text{ V} \\ V_{DD} &= 13 \text{ V; V}_{IS} = 5 \text{ V} \end{split}$		0.4 0.8 45	- - -	J ms A
I _{DM(SC)}	Peak drain current ⁴	$V_{IS} = 5 \text{ V}; V_{DD} = 13 \text{ V}$	-	105	-	Α
$T_{j(TO)}$	Over temperature protection Threshold junction temperature	$V_{IS} = 5 \text{ V}; \text{ from } I_D \ge 1 \text{ A}^5$	150	-	-	°C

TRANSFER CHARACTERISTIC

 $T_{mb} = 25 \, ^{\circ}C$

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
g _{fs}	Forward transconductance	V_{DS} = 10 V; I_{DM} = 13 A $t_p \leq 300~\mu s;$ $\delta \leq 0.01$	10	16	1	S

¹ Continuous input voltage. The specified pulse width is for the drain current.

² Refer to OVERLOAD PROTECTION LIMITING VALUES.

 $^{{\}bf 3}$ Continuous drain-source supply voltage. Pulsed input voltage.

⁴ Continuous input voltage. Momentary short circuit load connection. (The higher peak current is due to the effect of capacitance Cgd).

⁵ The over temperature protection feature requires a minimum on-state drain source voltage for correct operation. The specified minimum I_D ensures this condition.

Philips Semiconductors Product specification

PowerMOS transistor Logic level TOPFET

BUK109-50DL

INPUT CHARACTERISTICS

 $T_{mb} = 25$ °C unless otherwise specified. The supply for the logic and overload protection is taken from the input.

SYMBOL	PARAMETER	CONDITIONS		MIN.	TYP.	MAX.	UNIT
V _{IS(TO)}	Input threshold voltage	$V_{DS} = 5 \text{ V}; I_{D} = 1 \text{ mA}$		1.0	1.5	2.0	V
I _{IS}	Input supply current	normal operation;	$V_{IS} = 5 V$	100	200	350	μΑ
			$V_{IS} = 4 V$	-	160	270	μΑ
V_{ISR}	Protection reset voltage ¹		$T_i = 25 ^{\circ}C$	2.0	2.6	3.5	V
			$T_j = 150 ^{\circ}C$	1.0	-	-	
I _{ISL}	Input supply current	protection latched;	$V_{IS} = 5 V$	-	330	650	μΑ
			$V_{1S} = 3.5 \text{ V}$	-	240	430	μΑ
$V_{(BR)IS}$	Input breakdown voltage	$I_1 = 10 \text{ mA}$		6	-	-	V
R_{ig}	Input series resistance		$T_i = 25 ^{\circ}C$	-	33	-	kΩ
	to gate of power MOSFET		$T_{i} = 150 ^{\circ}\text{C}$	-	50	-	kΩ

SWITCHING CHARACTERISTICS

 T_{mb} = 25 °C. R_{I} = 50 Ω . Refer to waveform figure and test circuit.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
t _{d on}	Turn-on delay time	$V_{DD} = 13 \text{ V}; V_{IS} = 5 \text{ V}$	1	17	-	μs
t _r	Rise time	resistive load $R_L = 2.1 \Omega$	-	75	-	μs
t _{d off}	Turn-off delay time	$V_{DD} = 13 \text{ V}; V_{IS} = 0 \text{ V}$	ı	60	-	μs
t _f	Fall time	resistive load $R_L = 2.1 \Omega$	-	70	-	μs

REVERSE DIODE LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Is	Continuous forward current	$T_{mb} \le 25 ^{\circ}C; V_{IS} = 0 V$	-	26	Α

REVERSE DIODE CHARACTERISTICS

 $T_{mb} = 25 \, ^{\circ}C$

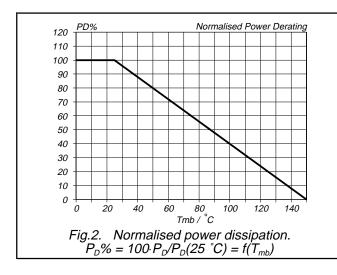
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{SDO}	Forward voltage	$I_S = 26 \text{ A}; V_{IS} = 0 \text{ V}; t_p = 300 \mu\text{s}$	1	1.0	1.5	V
t _{rr}	Reverse recovery time	not applicable ²	-	1	-	•

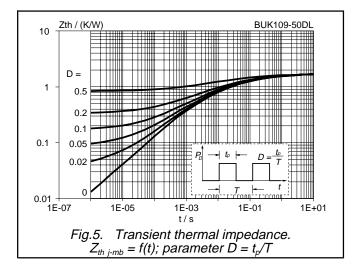
ENVELOPE CHARACTERISTICS

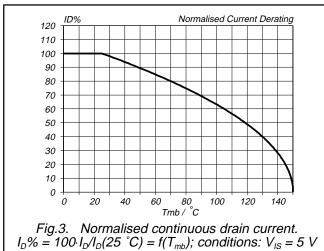
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
L _d	Internal drain inductance	Measured from upper edge of tab	-	2.5	-	nΗ
L _s	Internal source inductance	to centre of die Measured from source lead soldering point to source bond pad	-	7.5	-	nH

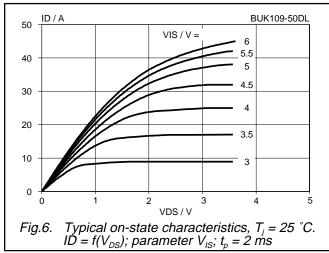
¹ The input voltage below which the overload protection circuits will be reset.

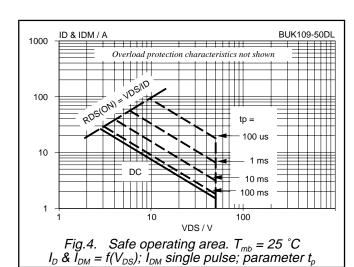
² The reverse diode of this type is not intended for applications requiring fast reverse recovery.

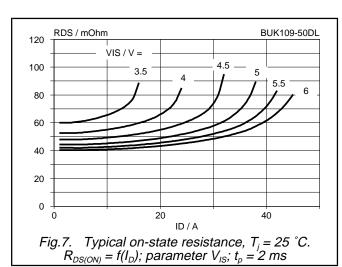












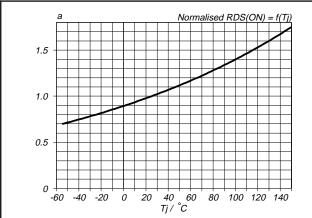


Fig.8. Normalised drain-source on-state resistance. $a = R_{DS(ON)}/R_{DS(ON)}25 \, ^{\circ}C = f(T_j); \, I_D = 13 \, A; \, V_{IS} = 5 \, V$

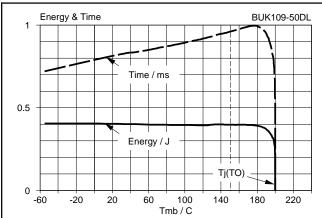


Fig.11. Typical overload protection characteristics. Conditions: V_{DD} = 13 V; V_{IS} = 5 V; SC load = 30 m Ω

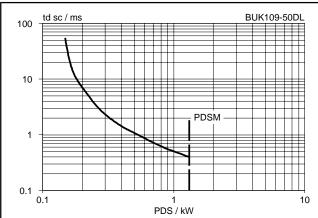


Fig.9. Typical overload protection characteristics. $t_{dsc} = f(P_{DS})$; conditions: $V_{IS} \ge 4 \text{ V}$; $T_j = 25 \text{ °C}$.

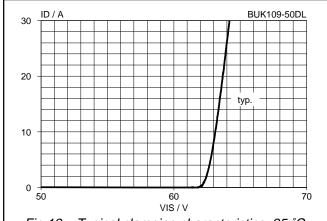


Fig.12. Typical clamping characteristics, 25 °C. $I_D = f(V_{DS})$; conditions: $V_{IS} = 0$ V; $t_p \le 50 \, \mu s$

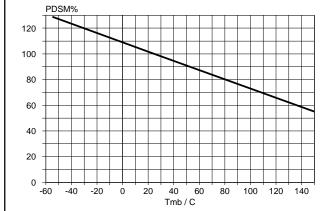
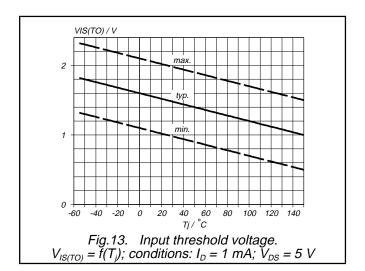


Fig.10. Normalised limiting overload dissipation. $P_{DSM}\% = 100 \cdot P_{DSM}/P_{DSM}(25 \, ^{\circ}C) = f(T_{mb})$



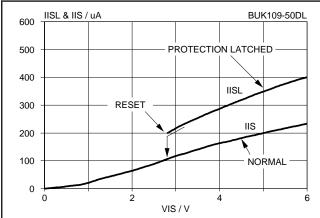
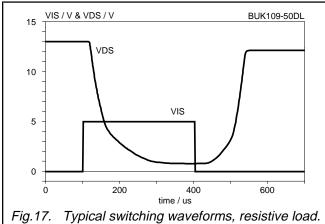
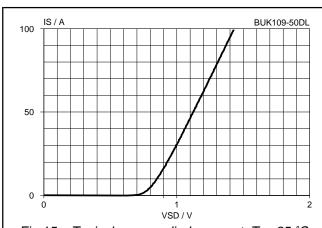


Fig.14. Typical DC input characteristics, $T_j = 25$ °C. $I_{ISL} \& I_{IS} = f(V_{IS})$; protection latched & normal operation



 $V_{DD} = 13 \text{ V}; R_L = 2.1 \, \Omega; R_I = 50 \, \Omega, T_i = 25 \, ^{\circ}C.$



Typical reverse diode current, $T_i = 25$ °C. $I_S = f(V_{SDS})$; conditions: $V_{IS} = 0$ V Fig.15.

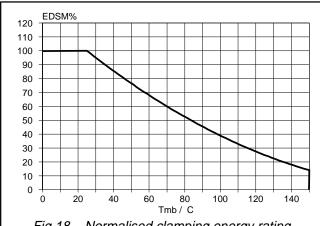


Fig.18. Normalised clamping energy rating. $E_{DSM}\% = f(T_{mb})$; conditions: $I_D = 26$ A; $V_{IS} = 5$ V

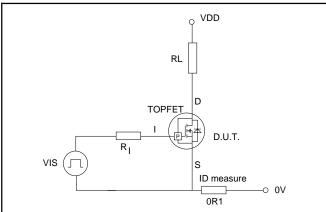
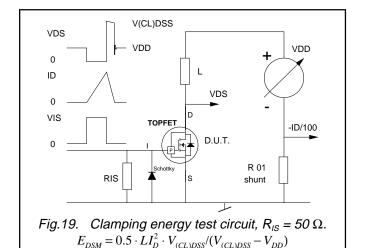
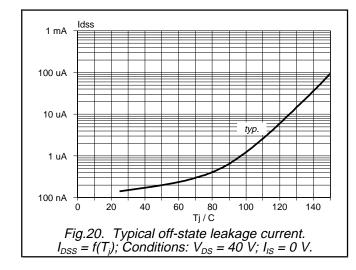


Fig.16. Test circuit for resistive load switching times.





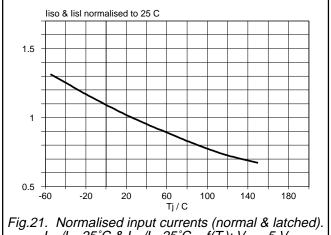
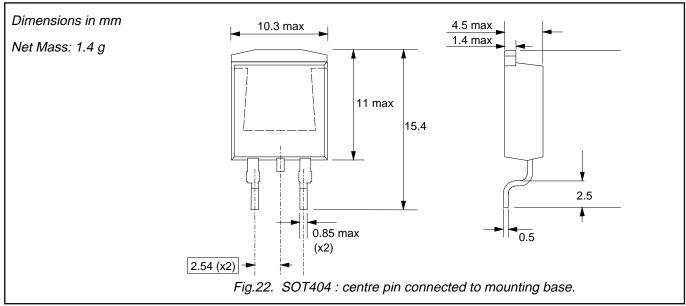


Fig.21. Normalised input currents (normal & latched). $I_{ISO}/I_{ISO}25^{\circ}C$ & $I_{ISL}/I_{ISL}25^{\circ}C$ = $f(T_{j})$; V_{IS} = 5 V

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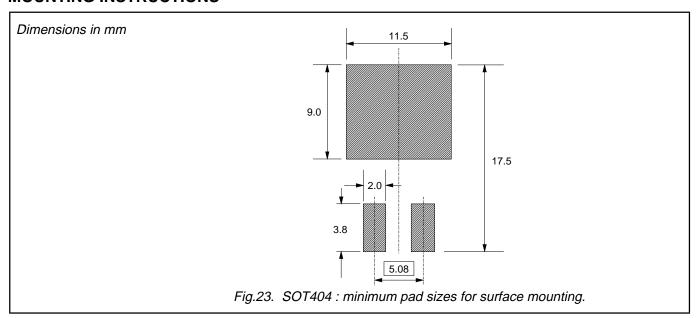
MECHANICAL DATA



Notes

1. Epoxy meets UL94 V0 at 1/8".

MOUNTING INSTRUCTIONS



Notes

1. Plastic meets UL94 V0 at 1/8".

BUK109-50DL

DEFINITIONS

Data sheet status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Product specification	This data sheet contains final product specifications.			

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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